

FIG. 1

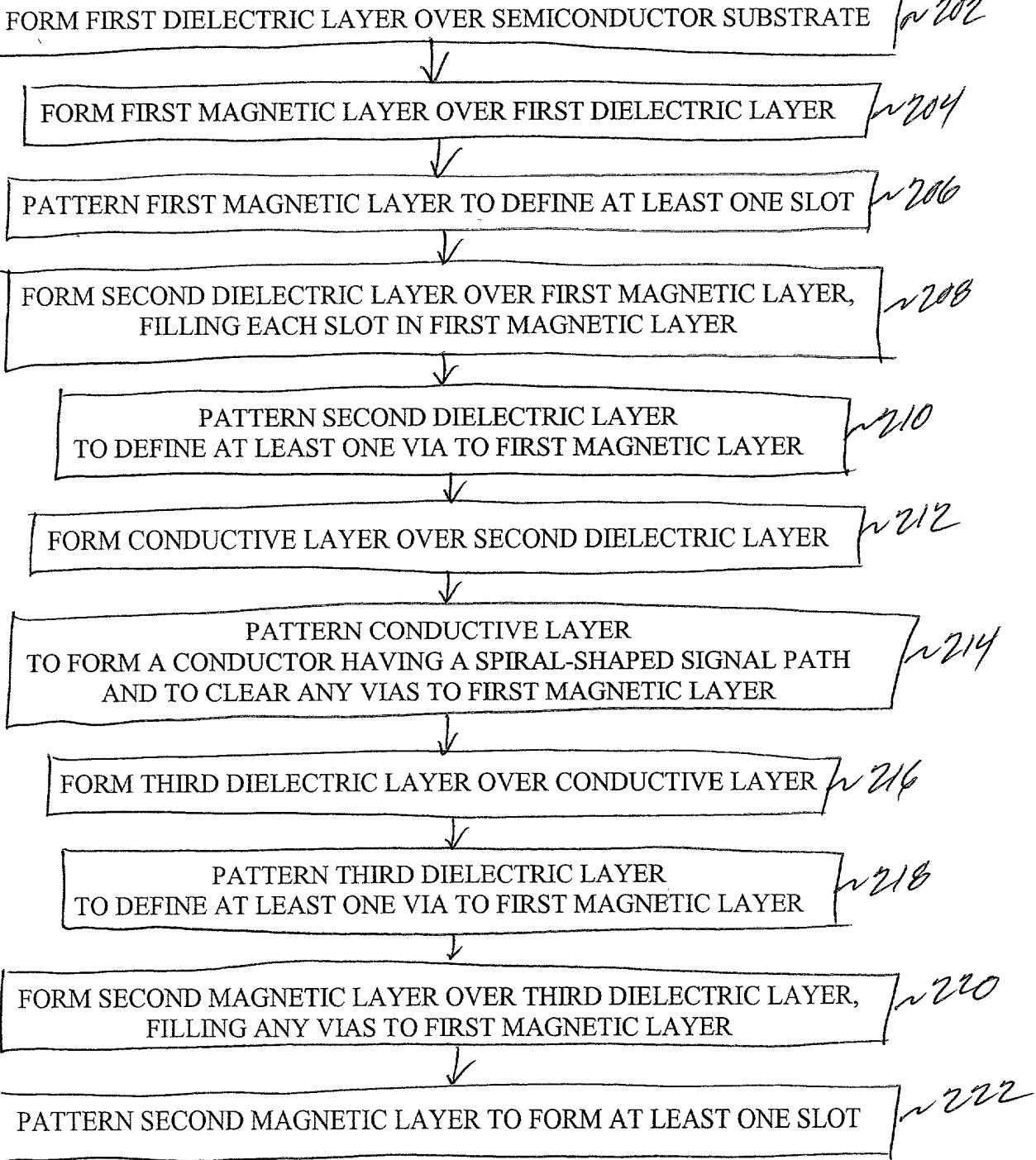


Fig. 2

00756152 - 044904

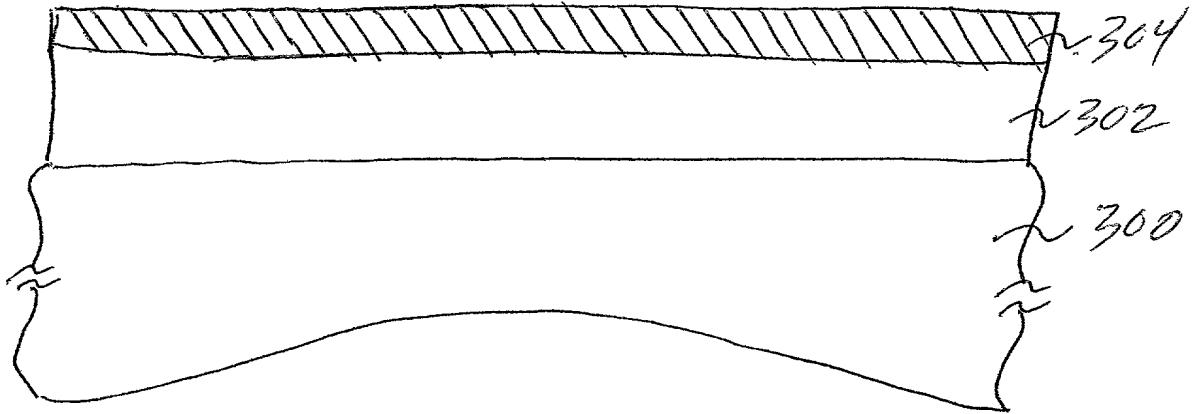


FIG. 3

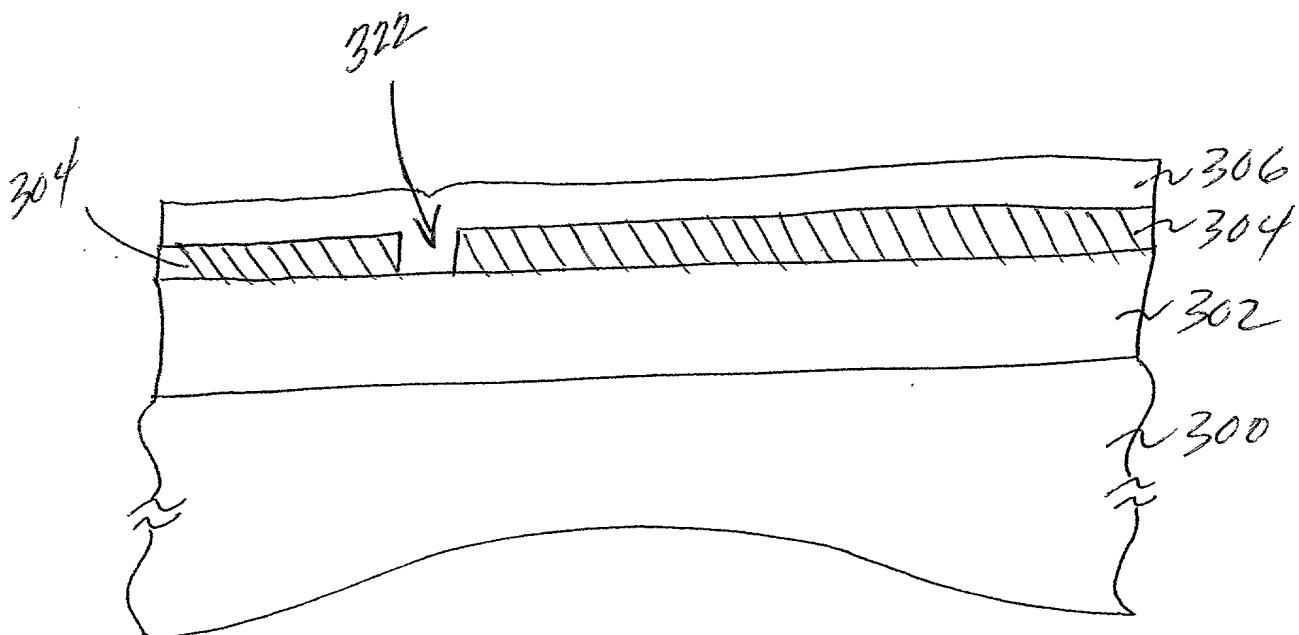


FIG. 4

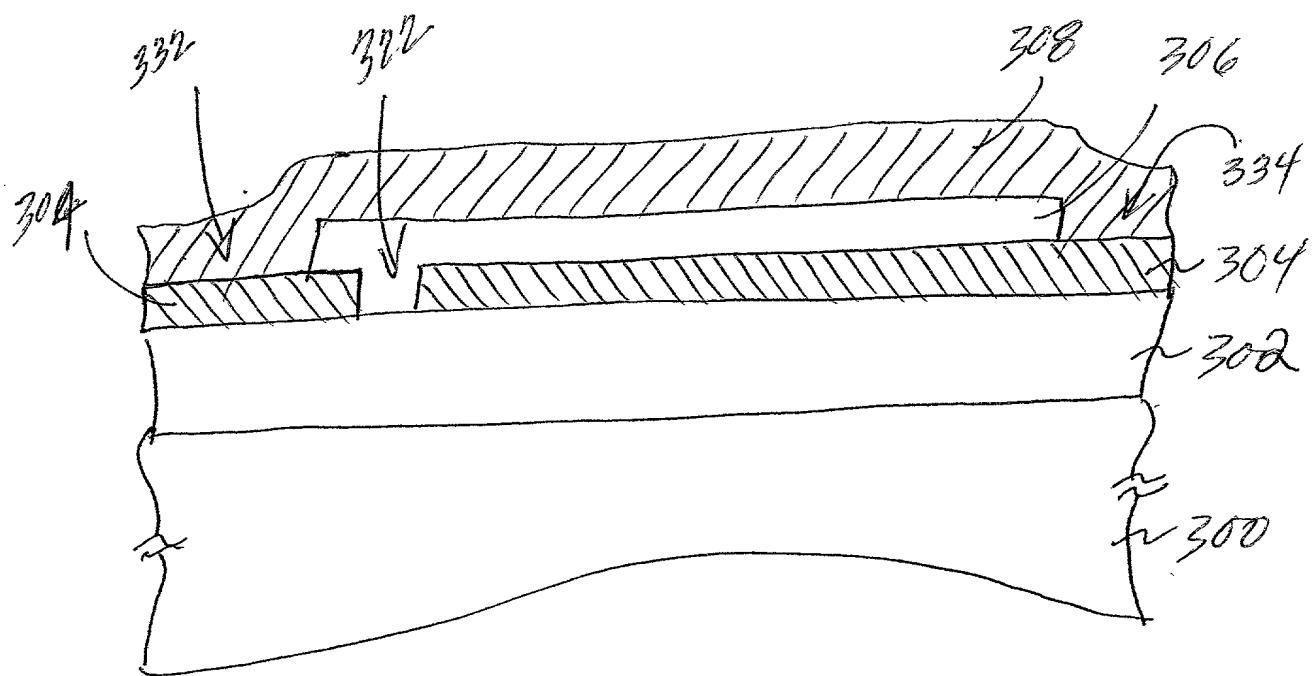


FIG. 5

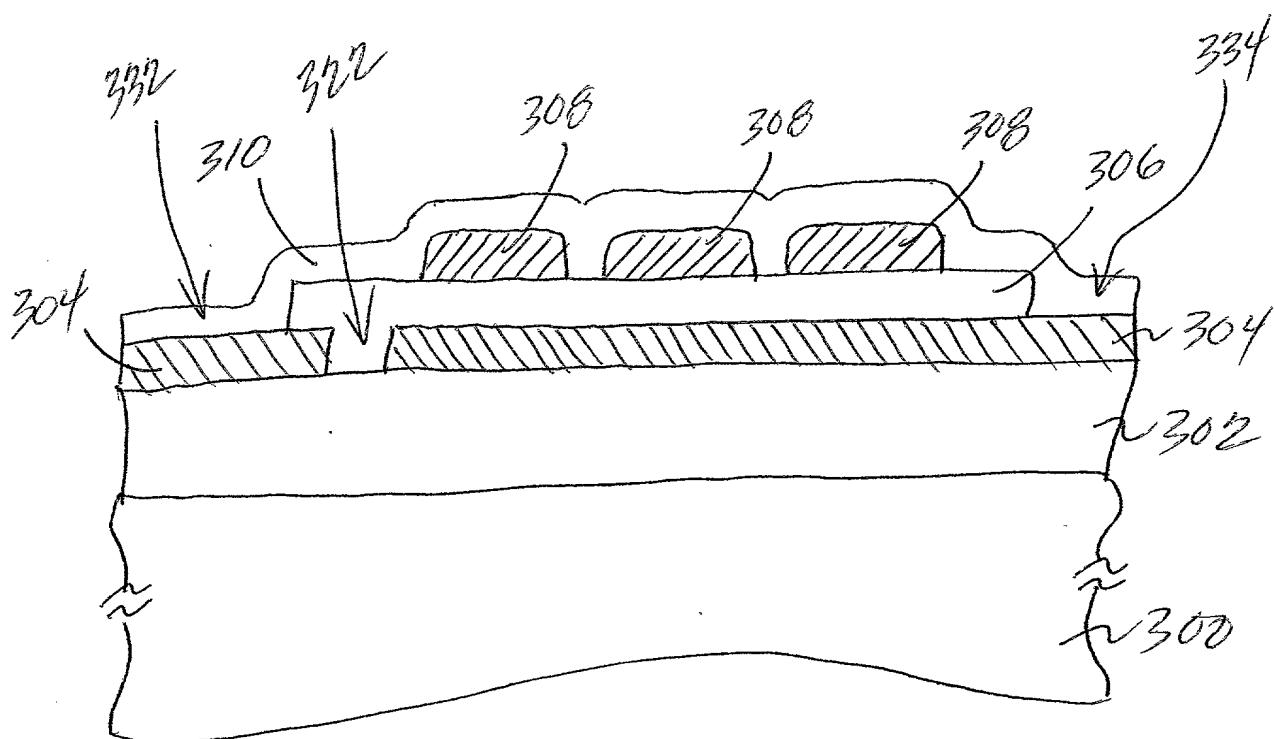


FIG. 6

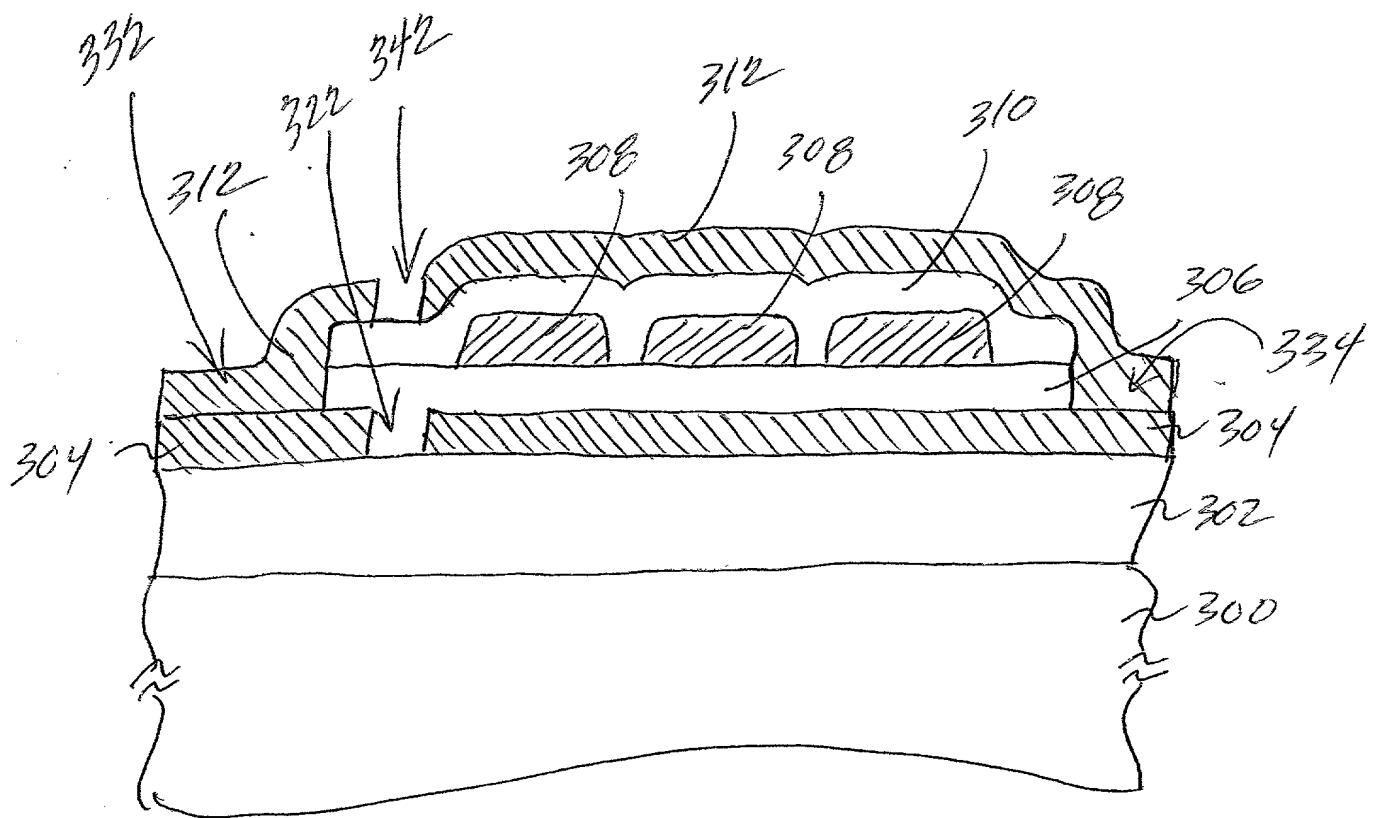


FIG. 7

801

FORM UNDERLYING LAYER OVER DIELECTRIC LAYER

~802

FORM MAGNETIC MATERIAL LAYER OVER UNDERLYING LAYER

~804

FORM OVERLYING LAYER OVER MAGNETIC MATERIAL LAYER

~806

FORM PATTERNED MASK LAYER OVER OVERLYING LAYER

~808

ETCH UNDERLYING, MAGNETIC MATERIAL, AND OVERLYING LAYERS

~810

Fig. 8

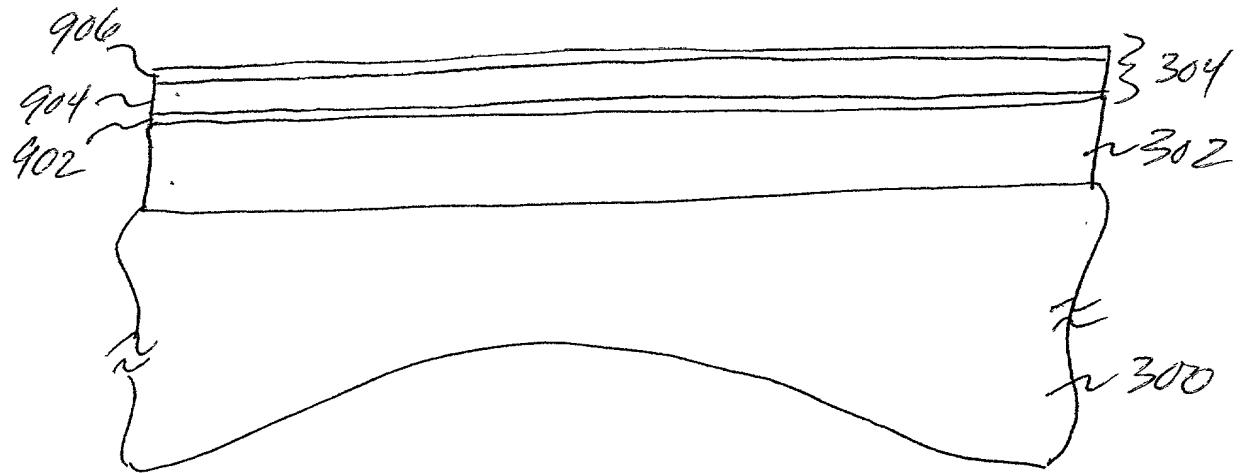


FIG. 9

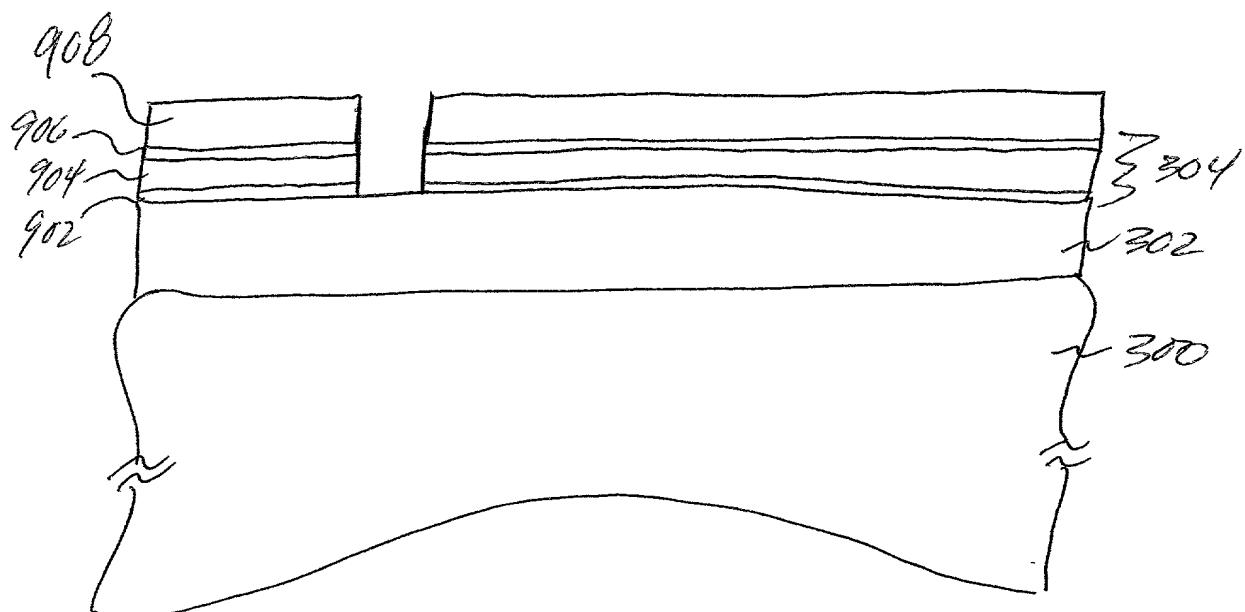


FIG. 10

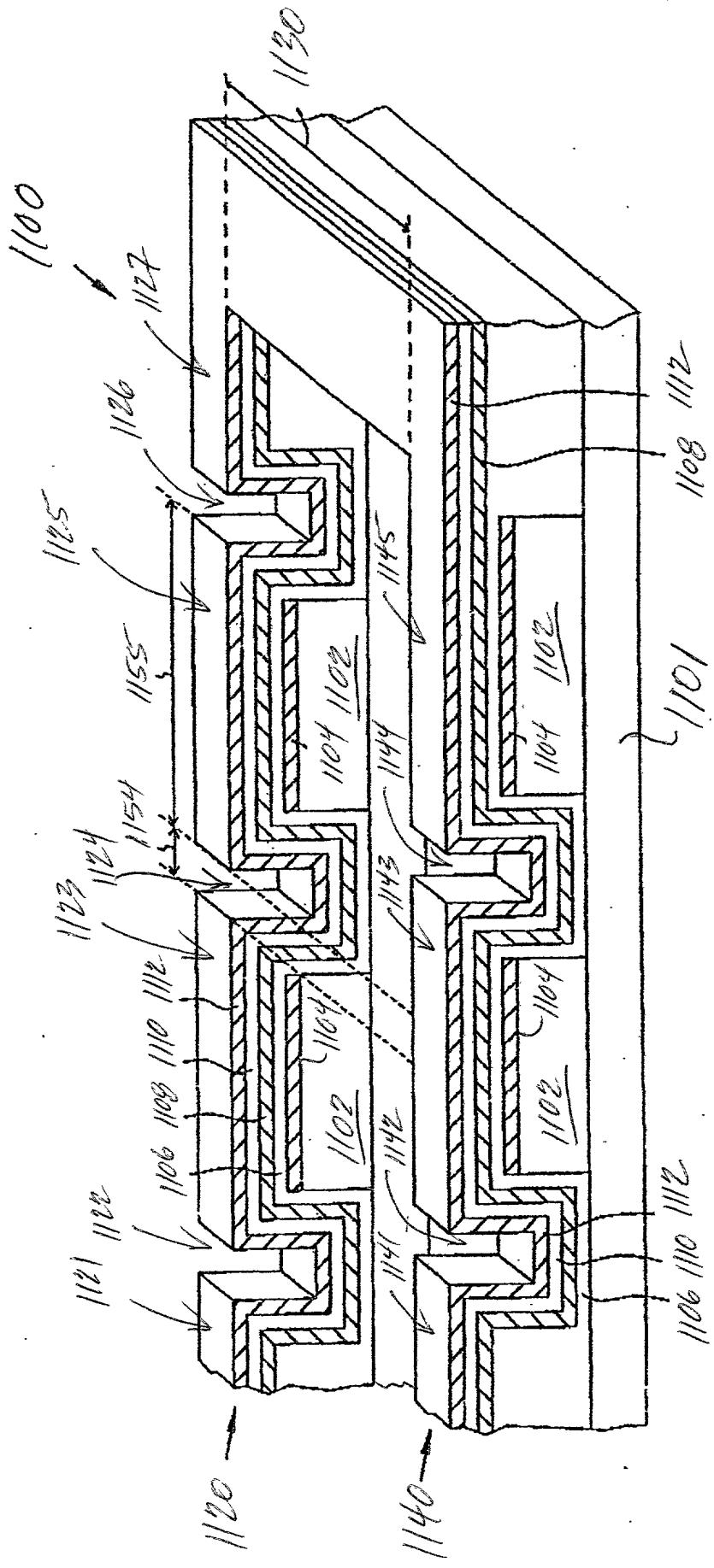


Fig. 11

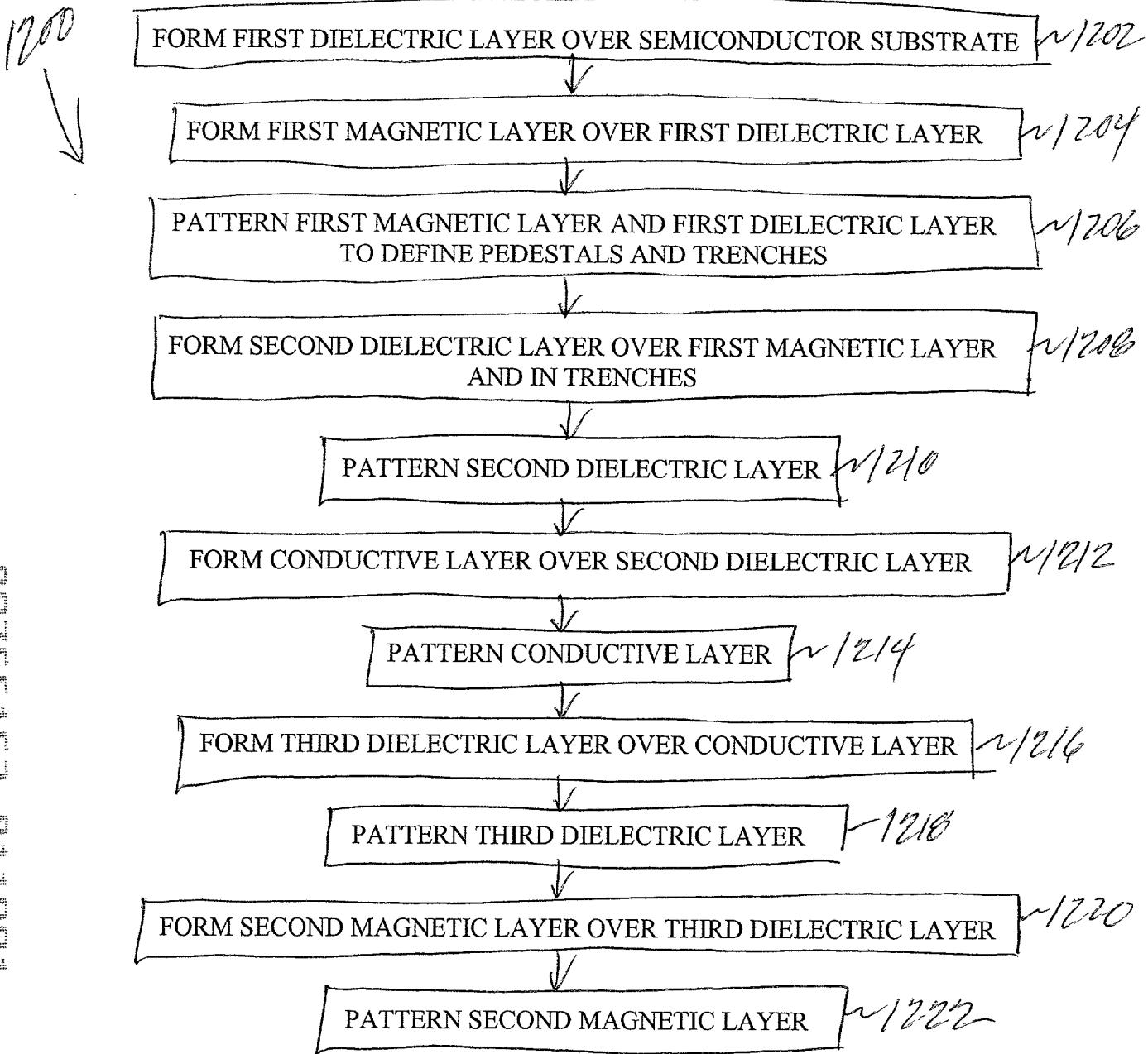


FIG. 12

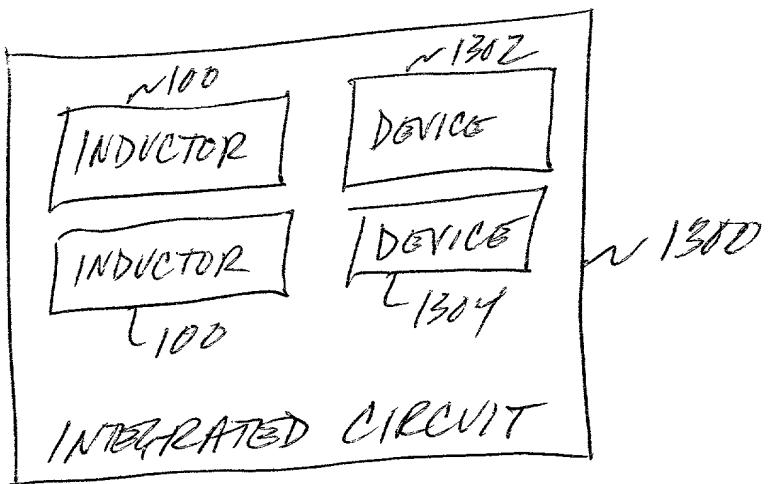


FIG. 13

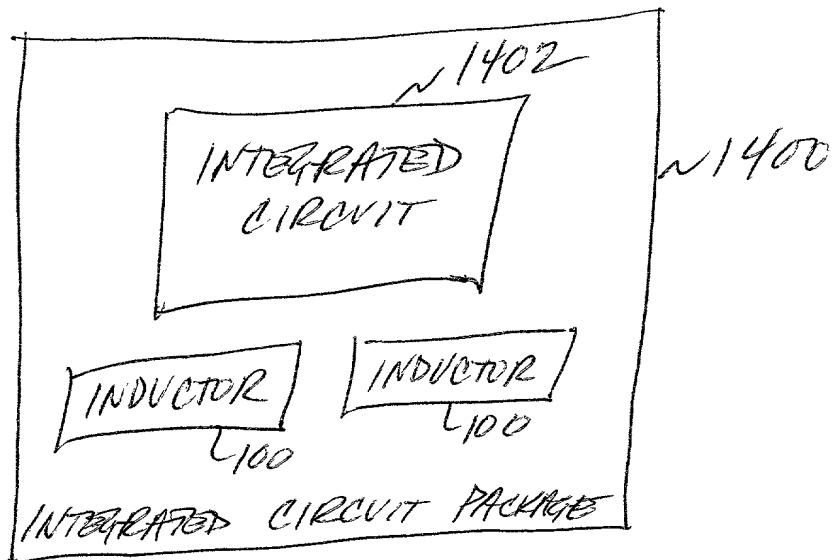


FIG. 14